# onsemi

# <u>MOSFET</u> – Power, Single, N-Channel

# 60 V, 185 A, 1.8 m $\Omega$

# NTMFS5H615NL

### Features

- Small Footprint (5x6 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- These Devices are Pb-Free and are RoHS Compliant

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Symbol	Parar	Value	Unit		
V <sub>DSS</sub>	Drain-to-Source Voltag	60	V		
V <sub>GS</sub>	Gate-to-Source Voltage			±20	V
I <sub>D</sub>	Continuous Drain		$T_{C} = 25^{\circ}C$	185	А
	Current R <sub>θJC</sub> (Notes 1, 3)	Steady	T <sub>C</sub> = 100°C	117	
PD	Power Dissipation			139	W
	R <sub>θJC</sub> (Note 1)		$T_{C} = 100^{\circ}C$	55	
Ι <sub>D</sub>	Continuous Drain		T <sub>A</sub> = 25°C	28	А
	Current R <sub>θJA</sub> (Notes 1, 2, 3)	Steady	$T_A = 100^{\circ}C$	18	
PD	Power Dissipation	State	T <sub>A</sub> = 25°C	3.2	W
	$R_{\theta JA}$ (Notes 1, 2) $T_A = 1$		T <sub>A</sub> = 100°C	1.3	
I <sub>DM</sub>	Pulsed Drain Current	T <sub>A</sub> = 25	°C, t <sub>p</sub> = 10 μs	900	А
T <sub>J</sub> , T <sub>stg</sub>	Operating Junction and Range	–55 to +150	°C		
۱ <sub>S</sub>	Source Current (Body D	116	А		
E <sub>AS</sub>	Single Pulse Drain-to-S Energy (I <sub>L(pk)</sub> = 16 A)	419	mJ		
ΤL	Lead Temperature for S (1/8" from case for 10 s		urposes	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Junction-to-Case - Steady State	0.9	°C/W
$R_{\theta JA}$	Junction-to-Ambient - Steady State (Note 2)	39	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

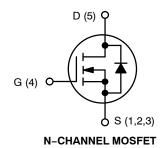
2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

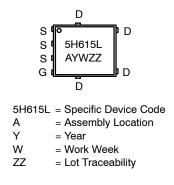
V <sub>(BR)DSS</sub> R <sub>DS(ON)</sub> MAX		I <sub>D</sub> MAX
60 V	1.8 mΩ @ 10 V	105.4
	$2.5~\mathrm{m}\Omega$ @ $4.5~\mathrm{V}$	185 A



DFN5 (SO-8FL) CASE 488AA STYLE 1



MARKING DIAGRAM



## **ORDERING INFORMATION**

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

#### ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
V <sub>(BR)DSS</sub>	Drain-to-Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 250 $\mu$ A		60			V
V <sub>(BR)DSS</sub> / T <sub>J</sub>	Drain-to-Source Breakdown Voltage Temperature Coefficient				37.8		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$ \begin{array}{c} V_{GS} = 0 \ V, \\ V_{DS} = 60 \ V \end{array} \qquad \begin{array}{c} T_{J} = 25 \ ^{\circ}C \\ T_{J} = 125 \ ^{\circ}C \end{array} $				10	
						250	μΑ
I <sub>GSS</sub>	Gate-to-Source Leakage Current	$V_{DS} = 0 V, V_{GS} = 20 V$				100	nA

**ON CHARACTERISTICS** (Note 4)

V <sub>GS(TH)</sub>	Gate Threshold Voltage	$V_{GS}$ = $V_{DS}$ , $I_D$ = 250 $\mu$ A		1.2		2.0	V
V <sub>GS(TH)</sub> /T <sub>J</sub>	Threshold Temperature Coefficient				-5.2		mV/°C
R <sub>DS(on)</sub>	Drain-to-Source On Resistance	V <sub>GS</sub> = 10 V I <sub>D</sub> = 49 A			1.5	1.8	mΩ
		V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 39 A		2.0	2.5	11152

#### **CHARGES, CAPACITANCES & GATE RESISTANCE**

C <sub>ISS</sub>	Input Capacitance		4860	
C <sub>OSS</sub>	Output Capacitance	$V_{GS}$ = 0 V, f = 1 MHz, $V_{DS}$ = 30 V	900	pF
C <sub>RSS</sub>	Reverse Transfer Capacitance		18	
Q <sub>OSS</sub>	Output Charge	$V_{GS}$ = 0 V, $V_{DD}$ = 30 V	79	
Q <sub>G(TOT)</sub>	Total Gate Charge	$V_{GS}$ = 10 V, $V_{DS}$ = 30 V; $I_{D}$ = 49 A	63	
Q <sub>G(TOT)</sub>	Total Gate Charge		28	nC
Q <sub>G(TH)</sub>	Threshold Gate Charge		7.7	nc
Q <sub>GS</sub>	Gate-to-Source Charge	$V_{GS}$ = 4.5 V, $V_{DS}$ = 30 V; $I_{D}$ = 49 A	14.2	
Q <sub>GD</sub>	Gate-to-Drain Charge		4.6	
V <sub>GP</sub>	Plateau Voltage		3	V

SWITCHING CHARACTERISTICS (Note 5)

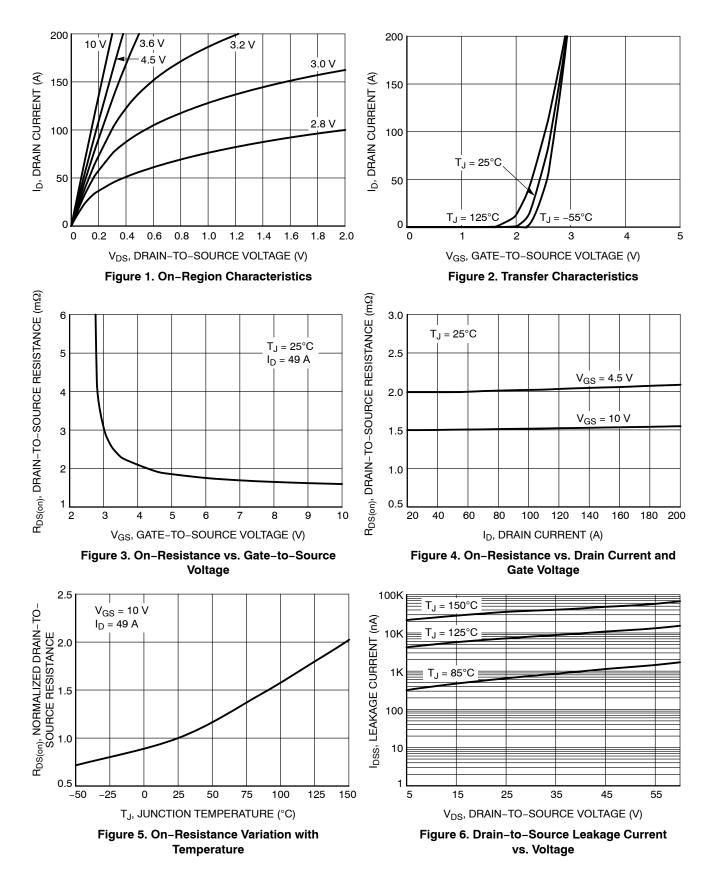
t <sub>d(ON)</sub>	Turn-On Delay Time		28	
t <sub>r</sub>	Rise Time	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 30 V,	116	20
t <sub>d(OFF)</sub>	Turn-Off Delay Time	$I_{\rm D}$ = 49 A, R <sub>G</sub> = 2.5 $\Omega$	63	ns
t <sub>f</sub>	Fall Time		138	

#### DRAIN-SOURCE DIODE CHARACTERISTICS

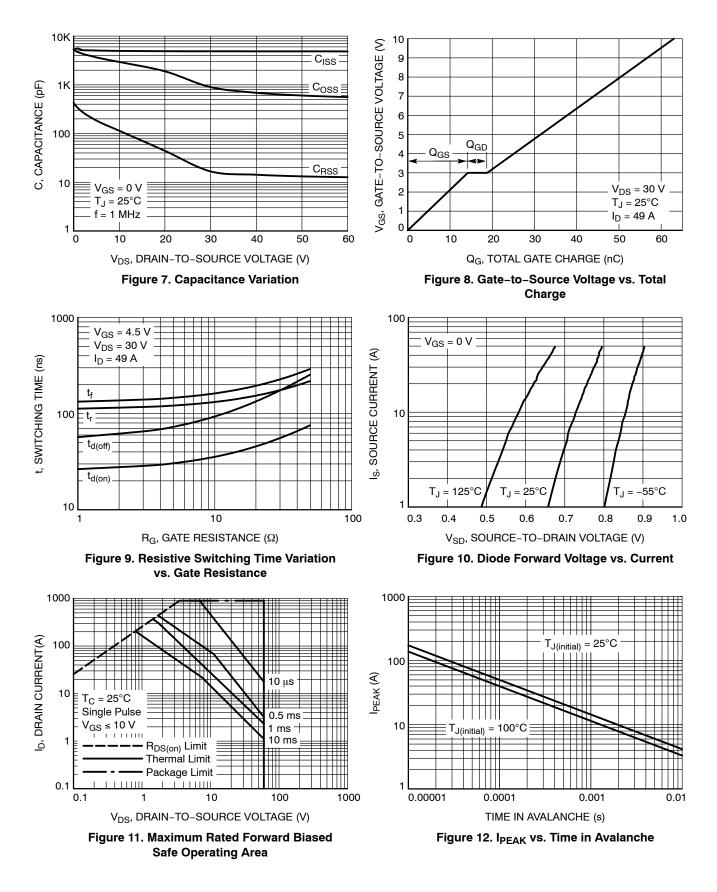
V <sub>SD</sub>	Forward Diode Voltage	$v_{GS} = 0 v,$	T <sub>J</sub> = 25°C	0.8	1.2	V
			T <sub>J</sub> = 125°C	0.65		v
t <sub>RR</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, dI <sub>S</sub> /dt = 100 A/µs, I <sub>S</sub> = 25 A		61		
t <sub>a</sub>	Charge Time			31		ns
t <sub>b</sub>	Discharge Time			30		
Q <sub>RR</sub>	Reverse Recovery Charge			76		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width  $\leq 300 \ \mu$ s, duty cycle  $\leq 2\%$ . 5. Switching characteristics are independent of operating junction temperatures.

## **TYPICAL CHARACTERISTICS**



#### TYPICAL CHARACTERISTICS (continued)



# TYPICAL CHARACTERISTICS (continued)

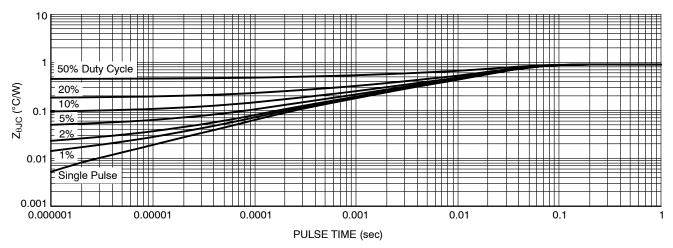


Figure 13. Thermal Characteristics

#### **DEVICE ORDERING INFORMATION**

Device	Marking	Package	<b>Shipping</b> <sup>†</sup>
NTMFS5H615NLT1G	5H615L	DFN5 (Pb-Free)	1,500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

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